Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1418	(semiconductor and alignment and pad$1 and position$1 and camera)	USPAT	OR	OFF	2005/09/02 15:41
S2	3	(semiconductor and alignment and pad$1 and position$1 and camera).clm.	USPAT	OR	OFF	2005/09/02 15:42
S3	4	324/770 and (semiconductor and alignment and pad$1 and position$1 and camera)	USPAT	OR	OFF	2005/09/02 16:18
S4	536	(semiconductor and alignment and pad$1 and position$1 and camera and identify$3)	USPAT	OR	OFF	2005/09/02 16:18
S5	336	(semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis)	USPAT	OR	OFF	2005/09/02 16:18
S6	146	(semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis and signal$1 and flexible)	USPAT	OR	OFF	2005/09/02 16:18
S7	134	(semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis and signal$1 and flexible and interface)	USPAT	OR	OFF	2005/09/02 16:19
S8	5	"324"/$.ccls. and (semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis and signal$1 and flexible and interface)	USPAT	OR	OFF	2005/09/02 16:26
S9	10	"324"/755 and (semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis)	USPAT	OR	OFF	2005/09/02 17:24
S10	16	"324"/754 and (semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis)	USPAT	OR	OFF	2005/09/02 17:24
S11	3	"324"/762 and (semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis)	USPAT	OR	OFF	2005/09/02 17:26
S12	10	"324"/158.1 and (semiconductor and alignment and pad$1 and position$1 and camera and identify$3 and axis)	USPAT	OR	OFF	2005/09/07 13:42
S13	98	"5974662"	USPAT	OR	OFF	2005/09/07 14:58

S14	1232	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1)	USPAT	OR	OFF	2005/09/07 14:59
S15	445	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and wir$3 and burn$3)	USPAT	OR	OFF	2005/09/07 15:00
S16	361	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and wir$3 and burn$3 and test$3 and lead$1)	USPAT	OR	OFF	2005/09/07 15:00
S17	59	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and wir$3 and burn$3 and test$3 and lead$1 and chip$1 and reduction)	USPAT	OR	OFF	2005/09/07 15:06
S18	0	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and wir$3 and burn$3 and test$3 and lead$1 and chip$1 and reduction).clm.	USPAT	OR	OFF	2005/09/07 15:07
S19	1	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and wir$3 and burn$3 and test$3).clm.	USPAT	OR	OFF	2005/09/07 15:07
S20	2	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and wir$3 and test$3).clm.	USPAT	OR	OFF	2005/09/07 15:07
S21	81458	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1and test$3).clm.	USPAT	OR	OFF	2005/09/07 15:07
S22	7	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and pad$1 and test$3).clm.	USPAT	OR	OFF	2005/09/07 15:08
S23	19	(semiconductor$1 and packag$3 and carrier$1 and socket$1 and test$3).clm.	USPAT	OR	OFF	2005/09/07 15:09
S24	25	(semiconductor$1 and carrier$1 same socket$1 and test$3).clm.	USPAT	OR	OFF	2005/09/07 15:13
S25	47	(semiconductor$1 same socket$1 and test$3 and chip$1).clm.	USPAT	OR	OFF	2005/09/13 10:56
S26	3	"6504389"	USPAT	OR	OFF	2005/09/13 10:56